

Wide Input sensorless CC/CV 1A Buck Converter

General Description

AT2001 is a wide input voltage, high efficiency step-down DC/DC converter that operates in either CV (Constant Output Voltage) mode or CC (Constant Output Current) mode. AT2001 provides up to 1.3A output current at 135kHz switching frequency without additional transistor.

Internal sensorless CC control eliminates the expensive, high accuracy current sense resistor, and making it ideal for battery charging applications and adaptors with accurate current limit. AT2001 achieves higher efficiency than traditional constant current switching regulators by eliminating the external current sense resister associated power loss.

Regarding protected function, thermal shutdown is to prevent over temperature operating from damage; cycle by cycle current limit is against over current operating of the switch; and over voltage protection (OVP) that can avoid high Vout voltage to damage circuit and capacitor.

The devices is available in SOT23-6L package and require very few external devices for operation.

Features

- ☐ Wide Input Voltage with 8V ~ 40V Operation
- ☐ Up to 1.3A Output Current
- ☐ Fixed Frequency 135 kHz with Easy EMI Control
- □ Internal fixed 1.3A constant current function
- ☐ AT2001Z Up to 2.5% Vout voltage compensation at 1A lout Load
- ☐ AT2001H Up to 5% Vout voltage compensation at 1A lout Load
- □ Patent Protected Sensorless CC Loop Control
 - -Lower BOM Cost , Higher System Efficiency
- ☐ Precision Feedback Voltage 1.2V+-1% Regulation
- ☐ Internal MOS 2A Current Peak Protected in Cycle by Cycle Current Limit
- ☐ SOT23-6 Package

Applications

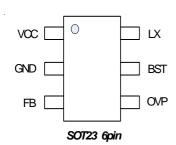
- □ Car Charger/Adaptor
- ☐ General-Purposed DC/DC Converters with Constant Current Limit
- □ Rechargeable Portable Devices

Ordering and Marking Information

Order Number	Package	Top Marking
AT2001ZST6	SOT23-6L	ZA
AT2001HST6	SOT23-6L	ZB

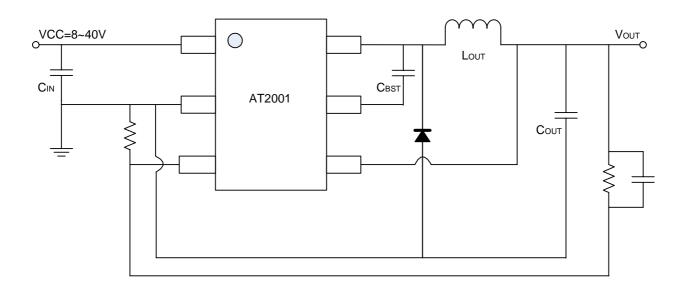
Note: Aplustek products are compatible with the current IPC/JEDEC J-STD-020 requirement. They are halogen-free, RoHS compliant and 100% matte tin (Sn) plating that are suitable for use in SnPb or Pb-free soldering processes.

Pin Configuration





Typical Application Circuit

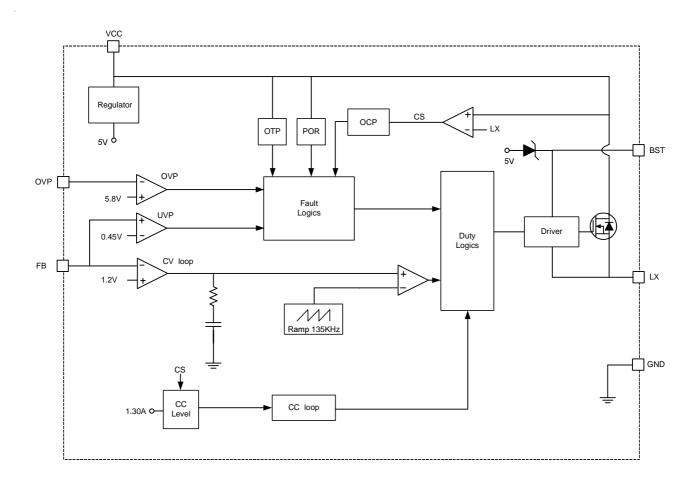


Function Pin Description

No.	Pin Name	Pin Function
1	VCC	Power Supply Input . Bypass this pin with a 0.1uF ceramic capacitor to GND, placed as close to the IC as possible.
2	GND	Ground.
3	FB	Feedback Input. The voltage at this pin is regulated to 1.2V.Connect to resistor divider between output and GND to set the output voltage.
4	OVP	OVP sense Pin. The pin is used to detect Vout voltage level.
5	BST	Bootstrap Bias Pin. It provides power to the internal high-side MOSFET gate driver. Connect a 0.1uF capacitor from BST to LX pin.
6	LX	Power Switching Output to external Inductor.



Function Blocks





Absolute Maximum Ratings

(Note1)	
Supply Input Voltage, V _{CC}	
BST to LX	0.3V to +7V
LX to GND DC	
FB,COMP to GND DC	
Storage Temperature Range	
Junction Temperature	
Lead Temperature Range(Soldering 10sec)	260°C
ESD Rating (Note2)	
HBM(Human Body Mode)	2KV
MM(Mechine Mode)	200V
Thermal Characteristics	
Package Thermal Resistance (Note3)	
SOT23-6L $\theta_{ extsf{JA}}$	200°C/W
Power Dissipation, PD @ TA = 25°C	
COTOO CI	0.45\\\

Electrical Characteristics

(V_{CC} = 12V, T_A = +25°C unless otherwise specified.)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Supply Input Section			•	•		
VCC operation range	V _{CC,R}		8		40	V
VCC UVLO threshold	$V_{\rm CC,R}$	VCC Rising		7.3		V
	V _{CC,F}	VCC Falling		6.2		V
VCC operation current	I _{cc}	VCC=8V to 40V , COMP short to FB		1	1.5	mA
Oscillation Section			,			•
PWM Frequency	F _{sw}			135		kHz
			-15%		+15	%
Max Duty	D _{MAX}			90		%
PWM loop Section						
Feedback reference voltage	V _{REF}			1.2		V
Feedback reference accuracy			-1%		+1%	%
Feedback Leakage		FB=1V			0.1	uA
Fault protection Section						
FB under voltage level	V _{UVP}			0.45		V
FB over voltage level	V _{OVP}			5.8		V
FB short Impedance level	V _{SHORT}			0.2		V
Over Tempherature level	T _{OTP}			150		°C
Over Tempperature level	T _{HYS}			40		°C



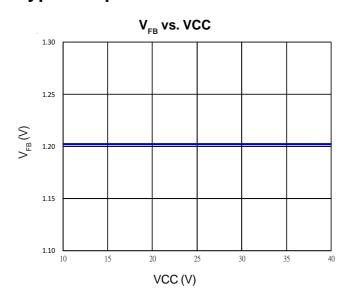


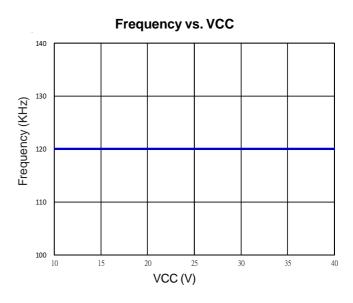
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units		
Fault protection Section								
CC Control accuracy		Vcc=10V~30V	-7		+7	%		
Vout Voltage Compensation		AT2001Z lout 1A loading		2.5		%		
Vout Voltage Compensation		AT2001H lout 1A loading		5		%		
Internal Soft Start time	T _{ss}			4.5		mS		
Fault recycle waitting time	T _{recycle}			0.5		S		
High side MOS Section						•		
High side MOS ON resistance	R _{DSON}			0.3		ohm		
High Side MOS peak current Limit				2		А		

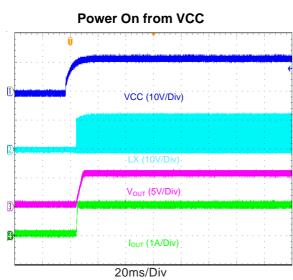
- **Note 1.** Exceeding these limits may impaire the life of the device. Exposure to absolute maximum rating conditions for long periods may affect device reliability.
- Note 2. θ_{JA} is measured with the component mounted on a high effective thermal conductivity test board in free air. The exposed pad of the package is soldered directly on the PCB.

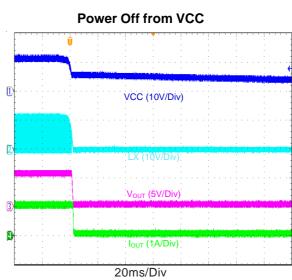


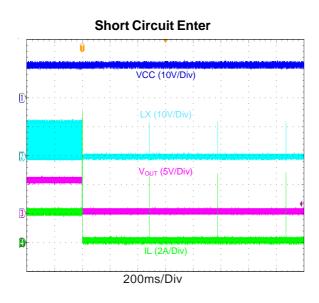
Typical Operation Characteristics

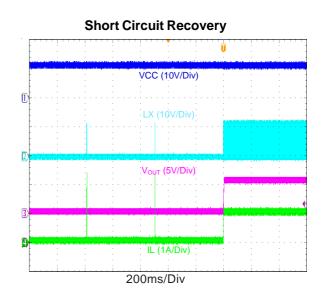








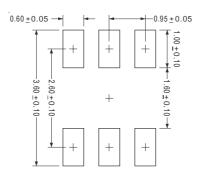






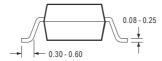
Package Information

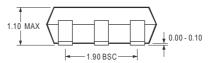
SOT23-6L



2.80 - 3.02 6 5 4 2.60 - 3.00 1 2 3 0.95 BSC

Recommended Solder Pad Layout





Note

1. Package Outline Unit Description:

BSC: Basic. Represents theoretical exact dimension .

MAX: Maximum dimension specified.

MIN: Minimum dimension specified.

REF: Represents dimension for reference use only. The value is not the device specification.

TYP: Represents as a typical value. The value is not the device specification.

2. All linear dimensions are in Millimeters.